

RedStone XP™

Show Your Best Every Time

mks | ESI



Higher throughput. Industry-leading power monitoring and control. ESI quality.

The RedStone XP™ system adopts proven design innovations from our premier products to deliver the ideal FPC processing solution for job shops facing significant product mix uncertainty. Process blind and through vias, rout and skive coverlay and thin printed circuit boards at high speeds and yields using ESI's compound beam positioning and patented Precision Pulse™ technology. With the added assurance of energy traceability and closed-loop power control that Precision Pulse™ provides, RedStone XP is a low-risk investment.



Enhanced Productivity

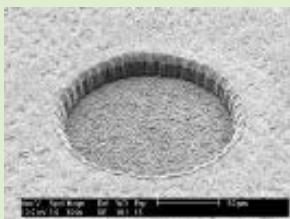
With RedStone's high frequency laser technology and the 5335's real-time power control capability, RedStone XP achieves high productivity at low cost for a larger range of applications.

High yields and high quality through Precision Pulse™ power control

Reduce your yield loss even for challenging depth-limited processes using ESI's industry-leading Precision Pulse™ power control. This feature continuously measures and adjusts the laser energy to the work surface material to ensure robust process quality every time.

Trusted yields, trusted partner

RedStone XP applies ESI's decades of laser-material interaction expertise to provide higher performance. This enables FPC manufacturers to drill high-density designs with an increased yield—while limiting incidental damage.



Confident processing of high-quality vias, with the best UV nsec routing on market

- High-quality blind vias
- High-power, high-frequency laser for maximum rout speed and quality

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Laser

Type Nanosecond UV laser

Pulse Rate 100-300 kHz

Laser Output Power 20W @ 100kHz

Automatic Alignment and Illumination

Coarse Camera Field of View 30 mm diagonal

Fine Camera Field of View 2 mm diagonal

Detection Device CCD, monochrome

Illumination LED

Laser Beam Positioning

Type Cross-axis brushless linear motor with digital galvanometer (Laser beam moves in XY, part moves in Y axis)

Panel Size 533 mm x 635 mm

Accuracy $\pm 20 \mu\text{m}$ over entire panel area

Maximum Average Velocity 500 mm/s

Peak Move Speed 2,000 points per second

Controller ESI Custom DSP based controller

Computer Interface

Computer Windows on Intel CPU with dual 500GB hard drives in RAID1 configuration.

Network Capability TCP/IP, 10/100/1000GBE

Drill File Formats DXF, ASCII, Excellon I and II, Sieb & Meier and Gerber using esiCAM software.

Programmable Z Stage

Resolution 1 μm

Maximum Average Velocity >10 mm/s

Repeatability $\pm 10 \mu\text{m}$

Travel 25 mm



Automation Capability

Software, mechanical and electrical interfaces provide the capability to attach web and panel material handlers to the system.

Ask an Expert! For facilities guidelines, requirements or more information, please contact your local MKS representative or visit www.esi.com.

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